

Sub C

- See A.1

operations, arithmetic operations, control operations, and memory operations, the integrated circuit being comprised of a plurality of groups, the groups being largely comprised of between 300 and 5000 gates, the groups being present in a library of groups, with each group being predefined in terms of logical and physical layouts, the physical layouts having predefined boundaries with predefined interconnection points along the physical boundaries, and at least some of the groups being amalgamated into functions, the functions being present in a library of function, the method comprising:

selecting an item, the item being a group or a function, for placement on a layout;  
 placing the item on the layout;  
 selecting a further item for placement on the layout;  
 placing the further item on the layout; and  
 defining interconnections between the item and the further item.

12. The method of claim 11 wherein the layout comprises a plurality of layers.

13. The method of claim 12 wherein the plurality of layers are separated by metalization having vias.

14. An integrated circuit comprised of a plurality of regularly placed circuit groups, the circuit groups being on an order of magnitude of 1000 gates, the circuit groups having predefined connection points, at least some of the circuit groups being amalgamated into sets of groups.

15. The integrated circuit of claim 14 further comprising trailers attached to groups.

16. The integrated circuit of claim 15 wherein the trailers provide physical translation of interface signals associated with the predefined connection points.

17. The integrated circuit of claim 15 wherein the trailers provide for buffering of interface signals associated with the predefined connection points.

18. The integrated circuit of claim 15 wherein the trailers provide for staging of interface signals associated with the predefined connections points.

Sub A-1  
Cont'd

Sub A-2  
FIG. 10

19. The integrated circuit of claim 14 wherein the integrated circuit has a number of metal layers, with the plurality of circuit groups on a first plurality of metal layers and clock and power signals on metal layers other than the first plurality of metal layers.

20. The integrated circuit of claim 19 wherein the clock and power signals are on the same metal layer.

21. The integrated circuit of claim 20 wherein global routing signals are on a metal layer other than the first plurality of metal layers or the metal layer of the clock and power signals.

22. The integrated circuit of claim 21 wherein the global routing signals are on a plurality of metal layers.

23. The integrated circuit of claim 19 wherein the groups comprise data path groups and memory groups.

24. The integrated circuit of claim 23 wherein the groups further comprise control groups.

25. The integrated circuit of claim 24 wherein the groups further comprise I/O groups.

26. The integrated circuit of claim 25 wherein the groups further comprise analog groups.

27. A process of designing an electronic logic system, the process comprising:

mapping groups to a functional description, the groups being comprised of up to 5000 gates, the groups being partitioned into data path groups, control groups, memory groups, I/O groups, and analog groups;

testing functional models of the mapped groups to verify the functional correctness of the mapping of groups to the functional description;

8 performing timing, area, and power estimation using detailed  
9 physical models of the mapped groups; and  
10 importing implementation files into the design.

1 28. The process of designing an electronic logic system of claim 27  
2 wherein the groups are predefined in terms of behavior, timing, power, and physical  
3 layout.

1 29. The process of designing an electronic logic system of claim 28  
2 wherein different sets of groups implement different functions.

1 30. The process of designing an electronic logic system of claim 29  
2 wherein groups within a set of groups implementing a function implement different  
3 behavior.

1 31. The process of designing an electronic logic system of claim 29  
2 wherein groups within a set of groups implementing a function have different physical  
3 layouts.

1 32. The process of designing an electronic logic system of claim 29  
2 wherein groups within a set of groups implementing a function have different power  
3 usage.

FOIEUO" 2h20h960